- Low Insertion Loss
- 5.0 X 7.0 mm Surface-Mount Case
- Complies with Directive 2002/95/EC (RoHS)

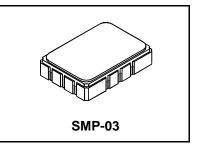


# SF1145B

### 427.250 MHz SAW Filter

#### **Absolute Maximum Ratings**

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range -40 to +85		
Suitable for lead-free soldering - Max Soldering Profile	260°C for 30 s	



#### **Electrical Characteristics**

Characteristic		Sym	Notes	Min	Тур	Max	Units
Nominal Center Frequency		f <sub>C</sub>	1	427.250			MHz
Passband	Insertion Loss at fc	IL				3.5	dB
	1.5 dB Passband	BW <sub>1</sub>		±15			kHz
	4.0 dB Passband		1, 2	30			MHz
Group Delay Varia	ation over fc ±250 kHz	GDV			177	250	ns <sub>P-P</sub>
Rejection (referenced to fc=427.250 MHz)	fc±1.5 MHz		1, 2, 3	5			
	fc±6.0 MHz		1, 2, 3	20			dB
	fc±50 MHz			50			
Operating Temperature Range		Τ <sub>Α</sub>	1	-40		+85	°C
Differential Input and Output Impedance after matching			50 ohms				•
Case Style		6 SMP-03 7 x 5 mm Nominal Footprir			orint		
Lid Symbolization (YY=year, WW=week, S=shift) See note 4					RFM SF1145	5B YYWWS	

#### **Electrical Connections**

Connection	Terminals
Port 1 Hot	10
Port 1 Ground Return	1
Port 2 Hot	5
Port 2 Ground Return	6
Case Ground	All Others

#### Notes:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to  $50 \Omega$  and measured with  $50 \Omega$  network analyzer.

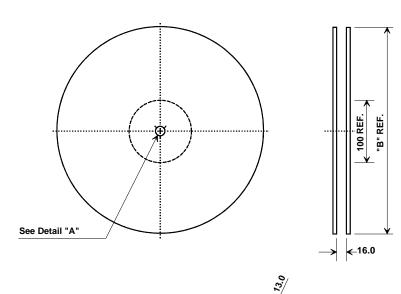
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.

- 3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- 4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."

5. The design, manufacturing process, and specifications of this filter are subject to change.

- 6. Tape and Reel Standard ANSI / EIA 481.
- 7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- 8. US and international patents may apply.
- 9. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
- 10. ©Copyright 1999, RF Monolithics Inc.
- 11. Electrostatic Sensitive Device. Observe precautions for handling.

### **Tape and Reel Specifications**



	B " nal Size	Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000

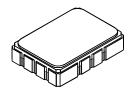
#### **COMPONENT ORIENTATION and DIMENSIONS**

2.0 2.0

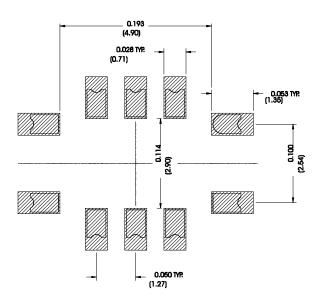
	Carrier Tape Dimensions	
	Ао	5.5 mm
	Во	7.5 mm
COVER TAPE SIZE	Ко	2.0 mm
	Pitch	8.0 mm
	w	16.0 mm
COVER TAPE (CARRIER TAPE	SIZE) N #1 A0 USER DIRECTION OF FEE	P (PITCH)

## SMP-03 Case

### 10-Terminal Ceramic Surface-Mount Case 7 x 5 mm Nominal Footprint



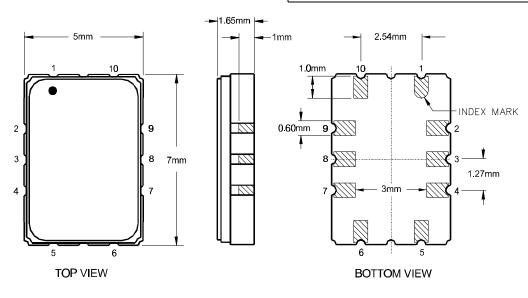
**Recommended PCB Footprint** 



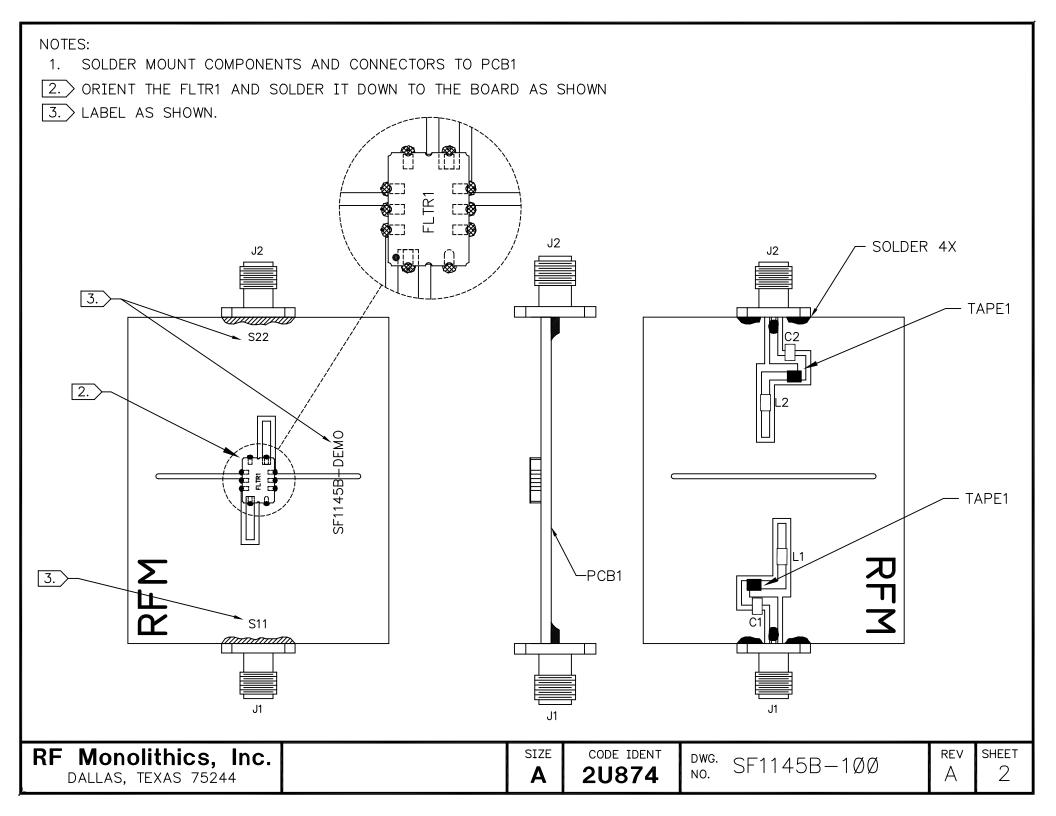
Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
Α	6.80	7.00	7.20	0.268	0.276	0.283
В	4.80	5.00	5.20	0.189	0.197	0.205
С		1.65	2.00		0.065	0.079
D		0.60			0.024	
E		2.54			0.100	
Н		1.0			0.039	
J		5.00			0.197	
K		3.00			0.118	
Р		1.27			0.050	

Electrical Connections				
	Connection	Terminals		
Port 1	Input or Return	10		
	Return or Input	1		
Port 2	Output or Return	5		
	Return or Output	6		
	Ground	All others		
Single	Ended Operation	Return is ground		
Differen	ntial Operation	Return is hot		

Materials				
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80- 200 ulnches (203-508 uM) Ni.			
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick			
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic			
Pb Free				



NOTES:			REV	ECN NO.	DESCRIPTION	APP/DATE
NOTES.			A	8548	INITIAL RELEASE	25febØØ
	5Ø OHM INPUT L1 $J_1$ $J_1$ $J_1$ $J_1$ $J_1$ $J_1$ $J_1$ $J_1$ $J_1$ C1 $I_2$ G G G G G G G G	.NG 15-		nH	50 OHM OUTPUT	
	SCHEMATI D.U.T. VIEWED FROM DOT INDICATES PIN 10	I TOP	-)			
DRAWN BY/DATE:	J.F.Christopherson 25febØØ	TITLE:	ASS	SEMBL	Y DIAGRAM, SF1145	5B-DEMO
RF Monoli DALLAS. TE	thics, Inc. XAS 75244	SIZE <b>A</b>	CODE ID		wg. SF1145B—100	rev sheet A 1/3



WER # 2 SF 1145B EPAT: 3602(#1) DENO BOARD #2 2/21/00 MARYED AS

